

FIG. 9A

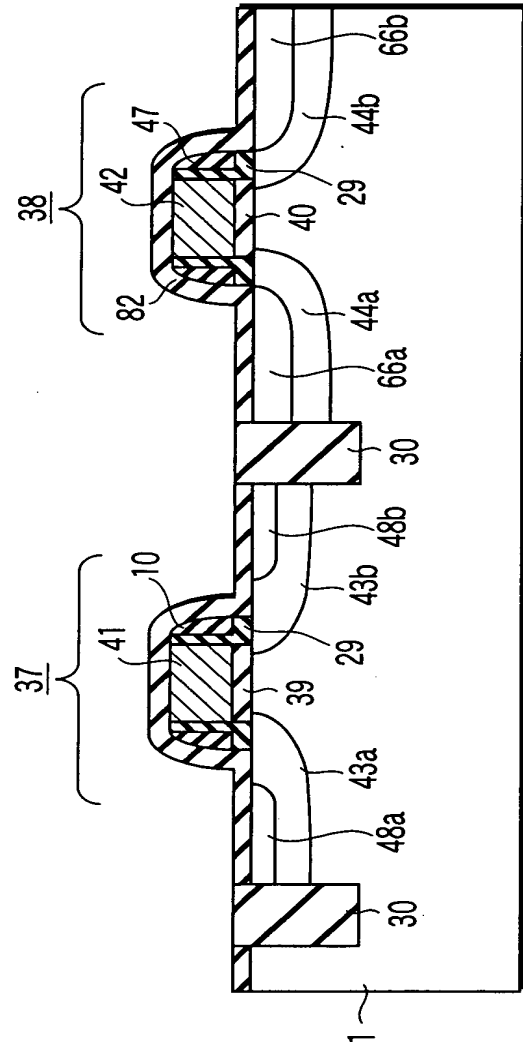


FIG. 9B

This cross-sectional view shows two semiconductor elements, 37 and 38, mounted on a substrate 29. Element 37 is on the left and includes a semiconductor element 10, a contact pad 41, and a conductive layer 39. Element 38 is on the right and includes a semiconductor element 82, a contact pad 42, and a conductive layer 40. Both elements are connected to a common conductive layer 44a, which is part of a larger conductive structure 44b. The substrate 29 is shown with a top layer 66a and a bottom layer 66b. The elements are separated by a gap 30.

FIG. 20B